

SPECIFICATION FOR APPROVAL

CUSTOMER:	鹿鸣
CUSTOMER P/N	
PART NO:	BCRHB127B-330M
DESCRIPTION:	SMD POWER INDUCTORS
PRODUCTS NO:	
PRODUCTS REV:	1
DATE:	2018-7-13

PURCHASER CONFIRMED				
10				
REMARK				

PRO	OVIDER ENGINEER DEPT.		
APPROVAL BY	CHECK BY	DRAWN BY	
	Yasir	chenlinli	

誠陽實業有限公司

寶誠電子有限公司

TAIWAN CHENG YANG COMPONENT CORP

CHENG TAIPELOFFICE

2F-1, NO. 176, Chine-Yi Road., Zhonghe District, New Taipei City, TAIWAN(R.O.C) 新北市中和區建一路176號2樓之一 POSTAL CODE: 23500

TEL NO .: +886-2- 8228-0930 FAX NO .: +886-2-8228-0929 E-mail: h21803@ms29.hinet.net



CHINA FACTORY



ZHUHAI BAO CHENG ELECTRONICSCO.,LTD Guan Tang Industrial Park, Tang Jia Wan Town, Zhuhai City, Guangdong Province, CHINA 中國廣東省珠海市塘家灣鎮官塘工業區

POSTAL CODE: 519085 TEL NO:86-756-3383187 FAX NO:86-756-3380704 E-mail: baocheng@baocheng.biz

昆山誠陽電子有限公司 KUNSHAN CHENG YANG ELECTRONICSCO.,LTDP Qiang-An Road., High-Tech. Industrial Park, Kunshan City, Jiangsu Province, China 江蘇省昆山市高科技工業園區強安路38號 POSTAL CODE: 215300 TEL NO:86-512-57823500 FAX NO:86-512-57823503 E-mail: kscy@taiwan-chengyang.com.tw

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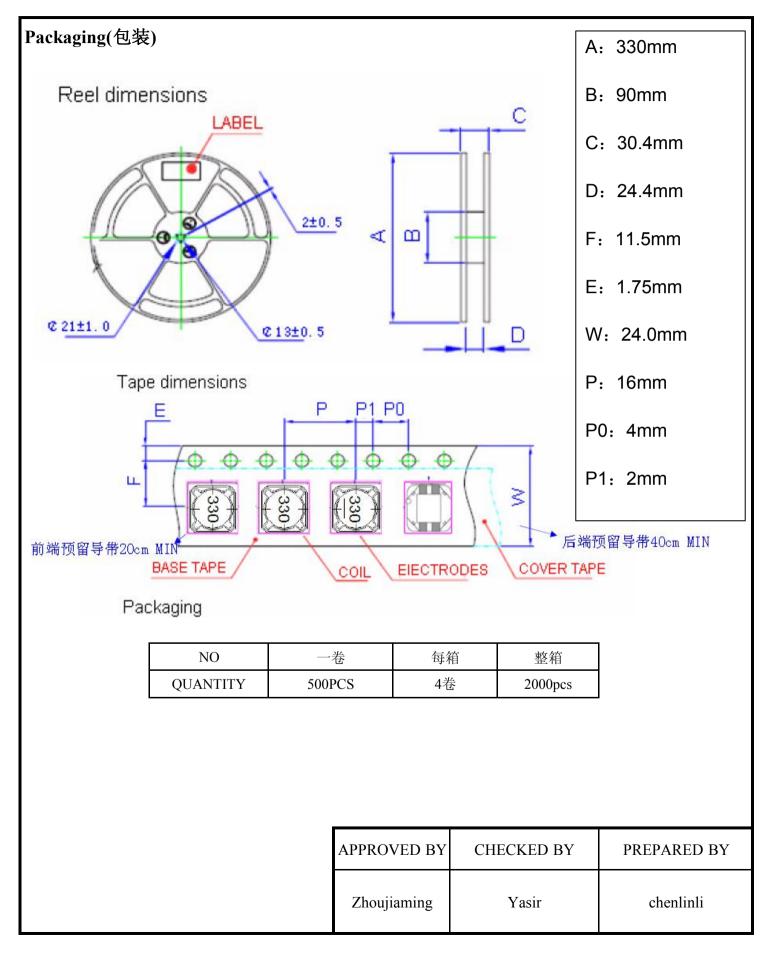
TEST DATA DIMENSION&ELECTRIC CHARACTER

DESCRIPTION: 1.SHAPE & DIMI I.SHAPE & DIMI IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	B D LAND	N (UNI	ERN DI		SERIES NO:	UNIT: A B	CRHB127B-330M
A C.RECOMMEND PAD LAYOUT(MM) 0.157	B D LAND	PATT	ERN DI	MENSIC		Α	12.5MAX
2.RECOMMEND PAD LAYOUT(MM)				MENSIC		Α	12.5MAX
2.RECOMMEND PAD LAYOUT(MM)				MENSIC			
2.RECOMMEND PAD LAYOUT(MM)				MENSIC		B	8.5MAX
PAD LAYOUT(MM)				MENSIC	DNS		
↓ → 0.217 5.5	-	E	ELECRE				
$\frac{0.217}{0.157}$	-	1	_	ICAL SC	HEMATIC:		
3.SEPCIFICATIO							
ELECREICA MEAS. ITEM	L SP	ECIF. SPE			TEST FREQ.		CONDITIONS
L1	33.0	μН	±	25%	100KHz/0.25V	610	5°C • Idc=0A
Isat-1	3.00	A	Max.		100KHz/0.25V	∆L/I	.≧-30%
DCR-1	136.0	mΩ	Max.			Ta=25	5°C
L2	33.0	μH	Ξ.	25%	100KHz/0.25V	Ta=25	5°C • Idc=0A
Isat-2	3.00	Α	Max.		100KHz/0.25V	<mark>∆L/I</mark>	.≧-30%
DCR-2	136.0	mΩ	Max.			Ta=25	5°C
DCR-1 L2 Isat-2	136.0 33.0 3.00	mΩ µH A	Max. ± Max.	25%	100KHz/0.25V	Ta=25 Ta=25 △L/L	5℃ 5℃,Idc=0A J≧-30%

Rohs Compliant KUNSHAN CHENG YANG ELECTRONICSCO.,LTDP TEST DATA FOR PREPRODUCTION SAMPLE

B.O.M (物料清單) 品名(Part No.):BCRHB127B-330M 项目名称 型号及规格 制造商 环保要求 序号 Project name manufacturers Type and specification NO. EN. QU 磁芯(DRUM CORE) TW40A DR10*7*6.2 STD 天文 RoHS 1 磁环(RING CORE) 天文 2 TW25A RI12. 2*6. 6*10. 8T (无倒脚) RoHS SC-DR9. 8-6(LS-B008-1) 3 BASE 硕诚(联诚备用) RoHS 线材 (WIRE) P180G1-0. 35mm/21. 5*2TS 益利素勒 RoHS 4 5 S-9001-6G 惠利 RoHS 胶水(GLUE) 6 TPG-X 骐富 RoHS 锡条(SOLDER) 千岛 7 107H RoHS 墨水(INK) 精工油墨 8 精工 RoHS APPROVED BY CHECKED BY PREPARED BY chenlinli Yasir

Rohs Compliant KUNSHAN CHENG YANG ELECTRONICSCO.,LTDP TEST DATA FOR PREPRODUCTION SAMPLE



GENERAL CHAR	ACTERISTICS page. 1		
Operation Temperature	-40°C to +125°C (Includes temperature when the coil is heated)		
External Appearance	On visual inspection, the coil has no external defects.		
Solder Ability Test	More than 90% of terminal electrode should be covered with solder. 1 After fluxing, component shall be dipped in a mel dipped in a melted. Solder:bath at 235°C \pm 5°C for 5 \pm 0.5senonds 150°C $= \frac{60}{5\pm0.5} = \frac{60}{5\pm0.5} = \frac{1}{5\pm0.5} = \frac{1}{5\pm$		
Heat endurance of Soldering	 1.Components should have not evidence of electrical and mechanical damage. 2.Inductance: within±10% of initial value. 3.Impedance: within±10% of initial value. Preheat:150±5°C 60seconds. Solder temperature: 250±5°C. Flux: rosin. Dip time:10±0.5 seconds. 		
Terminal Strength	After soldering of X,Y withstanding at below conditions .The terminal should not Peel off. (Refer to figure at below) 5N y		
Insulating Resistance	Over $100M\Omega$ at $100V$ D.C. between coil and core.		
Dielectric Strength	No dielectric breakdown at 30V D.C. for 1 minute between coil and core.		
VibrationTest	Inductance deviation within +10% after vibration for 1 hour. In each of three orientations at sweep vibration(10-~55-~10HZ)with 1.5mmP-P amplitudes		
Drop test	Inductance deviation within +10% after being dropped once with 981m/s2 (100G) shock Attitude upon a rubber block method shock testing machine, in three different orientations		
	dling lity of terminal electrodes: dity conditions: less than 40°C and 70% RH.		

(2) Products should be used within 6 months.

(3) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Handling

(1) Do not touch the electrodes(soldering terminals) with fingers as this may lead to deterioration of solderability.

(2) The use of tweezers or vacuum pick-ups is strongly recommended for individual components.

(3) Bulk handling should ensure that abrasion and mechanical shock are minimized.

GENERAL CHARACTE	ERISTICS	page. 2
TEST	Required Characteristics	Test Method/Condition
High Temperature StorageTest Reference documents: MIL-STD-202G Method108A	 No case deformation or change in appearance △L/L≤10% △Q/Q≤30% △DCR/DCR≤10% 	Temp 125°C High temperature 25°C 0°C High temperature 1H 1H 96H Test Time 76H Test Time Temperature: 125°C±2°C Time: 96±2 hours. Tested not less than 1 hour, nor more than 2 hours at room.
Low Temperature Storage Test Reference documents: IEC 68-2-1A 6.1 6.2	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	25°C 96H Test 0°C High temperature 40°C Temperature:-40°C±2°C Time:96±2 hours. Tested not less than 1 hour, nor more than 2 hours at room.
Humidity Test Reference documents: MIL-STD-202G Method103B	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	 Temp&Humidity 93%RH High temperature High humidity 96H Test Time 1. Dry oven at a temperature of 40°C±2°C for 96hours 2. Measurements At the end of this period 3. Exposure: Temperature: 40°C±2°C. Humidity:93±2hoyrs. 4. Tested while the chamber. 5. Tested not less than 1 hour. Nor more than 2 hours at room temperature.
Thermal Shock Test Reference documents: MIL-STD-202G Method107G	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	First-40°C for 30 Minutes, last 125°C for 30 Minutes as 1 cycle. Go through 20 cycles.

■Application Notice/Handling

(1) Temperature and humidity conditions : less than 40°C and 70% RH.

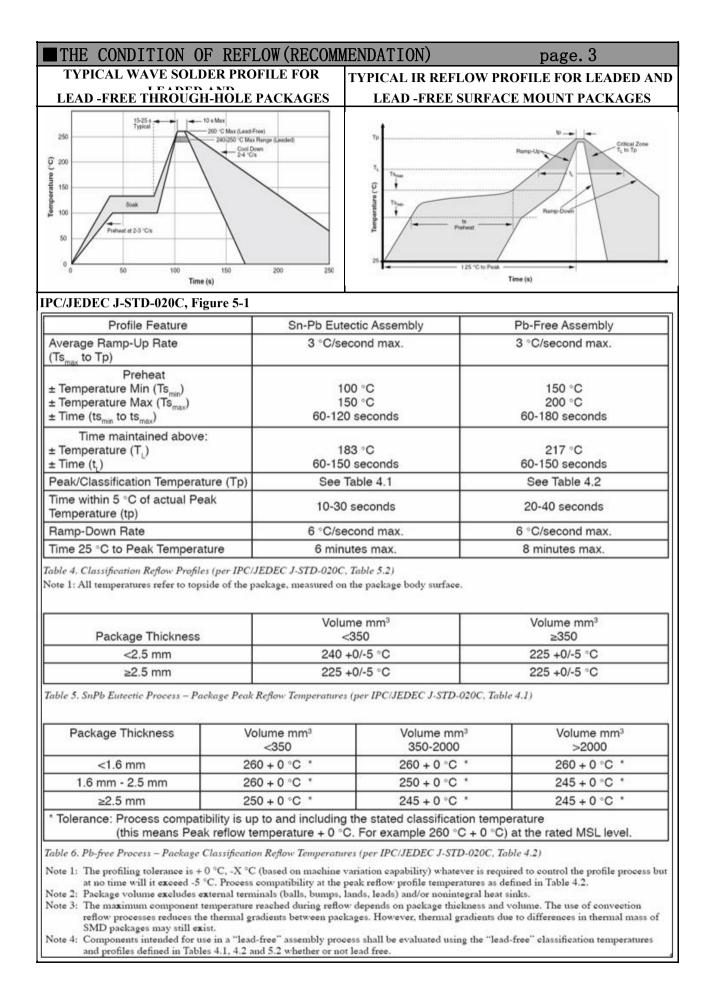
(2) Products should be used within 6 months.

(3) The packaging material should be kept where no chlorine or sulfur exists in the air.

(4) Do not touch the electrodes (soldering terminals) with fingers as this may lead to deterioration of solder ability

(5) The use of tweezers or vacuum pick-ups is strongly recommended for individual components.

(6) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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